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Vishay/Siliconix SIE804DF-T1-GE3

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Datasheet of SIE804DF-T1-GE3 - MOSFET N-CH 150V 37A POLARPAK

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New Product



SiE804DF

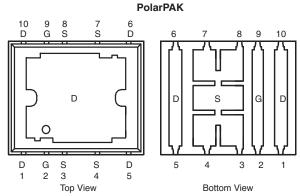
HALOGEN FREE

Vishay Siliconix

N-Channel 150-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	$R_{DS(on)}(\Omega)$ $I_D(A)^a$			
150	0.038 at V _{GS} = 10 V	37	46 nC		
	0.040 at V _{GS} = 6 V	36	40 IIC		

Package Drawing www.vishay.com/doc?64713



Top surface is connected to pins 1, 5, 6, and 10

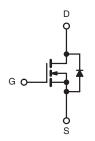
 $\textbf{Ordering Information:} \ \text{SiE} 804 \text{DF-T1-GE3} \ (\text{Lead (Pb)-free and Halogen-free})$

FEATURES

- Halogen-free According to IEC 61249-2-21
- TrenchFET[®] Power MOSFET
- Ultra Low Thermal Resistance Using Top-Exposed PolarPAK[®] Package for Double-Sided Cooling
- Leadframe-Based New Encapsulated Package
 - Die Not Exposed
 - Same Layout Regardless of Die Size, > 100 V
- 100 % R_q and UIS Tested

APPLICATIONS

- Primary Side Switch
- Half-Bridge



N-Channel MOSFET
For Related Documents
www.vishay.com/ppq?69091

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V_{DS}	150	V	
Gate-Source Voltage		V_{GS}	± 20		
	T _C = 25 °C		37		
Continuous Drain Current (T. – 150 °C)	T _C = 70 °C		29		
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	l _D	7.5 ^{b, c}		
	T _A = 70 °C		6 ^{b, c}		
Pulsed Drain Current		I _{DM}	50	A	
Continuous Source-Drain Diode Current	T _C = 25 °C		37		
	T _A = 25 °C	Is	4.3 ^{b, c}		
Single Pulse Avalanche Current	I _ 0.1 m∐	I _{AS}	25		
single Pulse Avalanche Energy L = 0.1 mH		E _{AS}	62	mJ	
	T _C = 25 °C		125		
Maximum Dawar Dissination	T _C = 70 °C	P _D	80	w	
Maximum Power Dissipation	T _A = 25 °C	LD	5.2 ^{b, c}	VV	
	T _A = 70 °C		3.3 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	
Soldering Recommendations (Peak Temperature) ^{d, e}			260		

Notes:

- a. $T_C = 25$ °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. See Solder Profile (<u>www.vishay.com/doc?73257</u>). The PolarPAK is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

Document Number: 69091 S09-0143-Rev. A, 02-Feb-09



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THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{a, b}	t ≤ 10 s	R_{thJA}	20	24		
Maximum Junction-to-Case (Drain Top)	Steady State	R _{thJC} (Drain)	0.8	1	°C/W	
Maximum Junction-to-Case (Source) ^{a, c}	Steady State	R _{thJC} (Source)	2.2	2.7		

Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
- b. Maximum under Steady State conditions is 68 °C/W.
- c. Measured at source pin (on the side of the package).

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static			•				
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	150			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA		175		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			- 7			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_{D} = 250 \mu A$	1		3	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 150 V, V _{GS} = 0 V			1	, , ,	
		V _{DS} = 150 V, V _{GS} = 0 V, T _J = 55 °C			10	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	25			Α	
Drain-Source On-State Resistance ^a	B	V _{GS} = 10 V, I _D = 7.6 A		0.031	0.038	Ω	
	R _{DS(on)}	$V_{GS} = 6 \text{ V}, I_D = 7.4 \text{ A}$		0.032	0.040		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 7.6 A		40		S	
Dynamic ^b			•				
Input Capacitance	C _{iss}	;		3000			
Output Capacitance	C _{oss}	V _{DS} = 50 V, V _{GS} = 0 V, f = 1 MHz		210		pF	
Reverse Transfer Capacitance	C _{rss}			110			
Total Cata Charge	Q _g	$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 7.6 \text{ A}$		70	105	nC	
Total Gate Charge		$V_{DS} = 50 \text{ V}, V_{GS} = 6 \text{ V}, I_D = 7.6 \text{ A}$		46	70		
Gate-Source Charge	Q _{gs}			11			
Gate-Drain Charge	Q _{gd}			19			
Gate Resistance	R _g	f = 1 MHz		2.1	4.2	Ω	
Turn-On Delay Time	t _{d(on)}			20	30		
Rise Time	t _r	V_{DD} = 75 V, R_L = 12.5 Ω		15	25		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 6 \text{ A}, V_{GEN} = 6 \text{ V}, R_g = 1 \Omega$		40	60	ns	
Fall Time	t _f			12	20		
	t _{d(on)}			15	25	115	
Outhorise Time	t _r	$V_{DD} = 75 \text{ V}, R_L = 12.5 \Omega$ $I_D \cong 6 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		10	15		
Switching Time	t _{d(off)}			42	65		
	t _r			10	15		
Drain-Source Body Diode Characteristic	s		•				
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			37		
Pulse Diode Forward Current ^a	I _{SM}				25	Α	
Body Diode Voltage	V _{SD}	I _S = 6 A		0.8	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}	-		70	110	ns	
Body Diode Reverse Recovery Charge		L = 6 A dl/dt = 100 A/vo T = 05 °C		220	330	nC	
Reverse Recovery Fall Time	t _a	$I_F = 6 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		54		ns	
Reverse Recovery Rise Time	t _b			16			

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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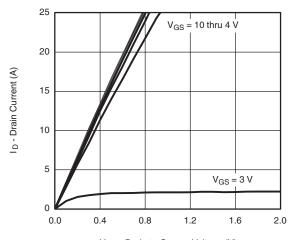
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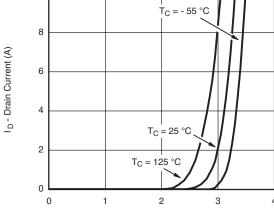
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

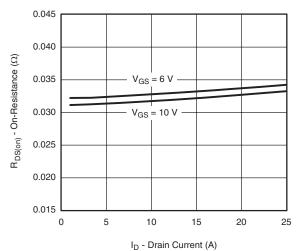


V_{DS} - Drain-to-Source Voltage (V)

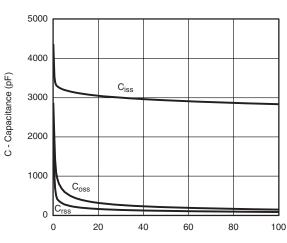


V_{GS} - Gate-to-Source Voltage (V) **Transfer Characteristics**

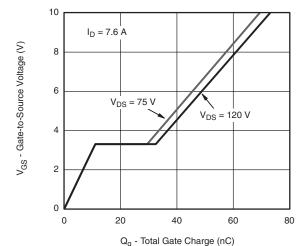




On-Resistance vs. Drain Current and Gate Voltage

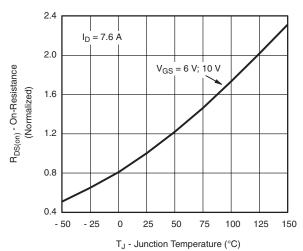


V_{DS} - Drain-to-Source Voltage (V)



Gate Charge

Capacitance



On-Resistance vs. Junction Temperature

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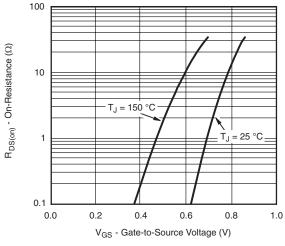
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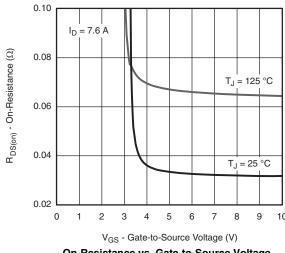
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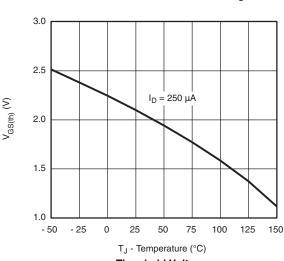
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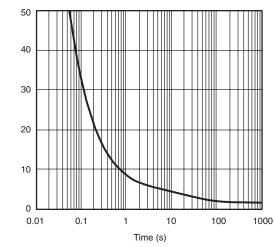
Source-Drain Diode Forward Voltage



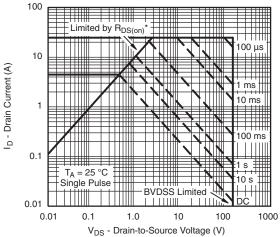
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient



Power (W)

* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

Safe Operating Area, Junction-to-Ambient



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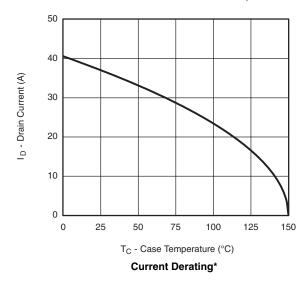


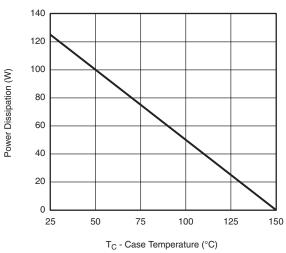


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Power Derating, Junction-to-Case

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^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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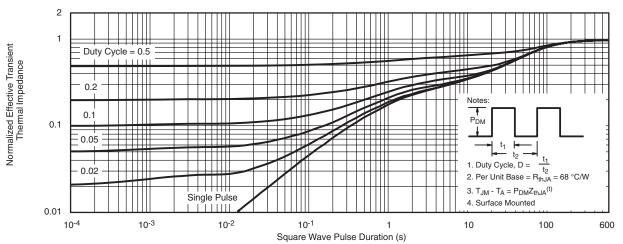
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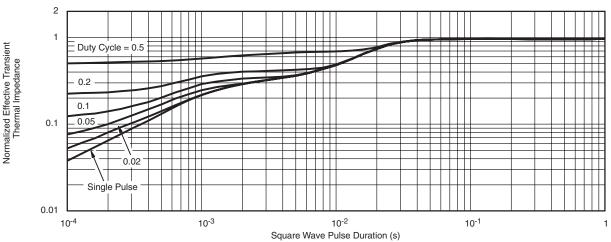
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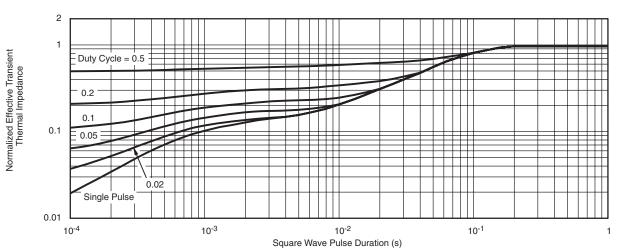
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Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case (Drain Top)



Normalized Thermal Transient Impedance, Junction-to-Source

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg269091.



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